



THERMALBOARD

SUSTAINABLE RADIANT HEAT PANEL SYSTEM JOB: DESIGNER: CONTACT:

PRODUCT DESCRIPTION

Thermalboard is a modular radiant panel system comprised of grooved rice straw MDF boards laminated with aluminum designed to be used in new construction and remodeling over a sub-floor or when properly installed, over cement. The two board types in the Thermalboard system have two patterns; straight and end combo that are laid out and installed in a pattern and attached by means of construction adhesive combined with screws or cross stapling as recommended in the Installation Manual. The pattern creates the pathway into which 3/8" nominal ASTM F 876-877 PEX (cross-linked polyethylene) tubing is placed.

TECHNICAL SPECIFICATIONS

Board Construction: 92% recycled content. Certified to extra moisture-resistant standard MR-30.	PEX Tube Spacing: 8" OC
Nominal Dimensions: 16" x 48"	Weight: 2.2 lb. /sq. ft. 18lb/ board
Thickness: 5%"	Typical Board Mix: 62% straight. 38% Curves.
Surface: .003 Aluminum Laminate	Pallet Size: 4'x4'x32" Full.
PEX: ¾" Nominal	Pallet Capacity: 74 Boards per Full Pallet.
Groove Depth: 1/2	Packaging: Corner protected. Shrink Wrapped
No Added Formaldehyde NAF	More Information

(800) 513-2648

thermalboardradiantfloorheating.com

Thermalboard Performance

HOW TO USE THE PERFORMANCE CHART

EKMA

SUSTAINABLE RADIANT HEAT PANEL SYSTE

Most manufacturers publish this data or it is available in this format from third-party engineers and manufacturers. The chart demonstrates the supply water temperature required to meet a given heat loss (BTU/Sq/Ft.) with a certain finished floor assembly resistance (R-Value). A low R-value of R=.05 would be tile, while a carpet with a carpet pad might be R=2.5. So for example, start at 20 BTU/Sq/Ft. on the X axis, go over to R=1 (hardwood) and go down and it will read about 105F.

PROJECT SHOP DRAWINGS





STRAIGHT: TBE-S1 VARIABLE: TBE-T1 COMBO: TBE-C1

This Thermalboard project shall be provided detailed project specific CAD drawings and schedules upon acceptance. System shall be installed as described in the current edition of the Thermalboard Installation Manual.